8-bit serial-in/serial-out or parallel-out shift register with output latches Rev. 6 — 26 May 2020 Product data

Product data sheet

1. General description

The 74AHC595; 74AHCT595 is an 8-bit serial-in/serial or parallel-out shift register with a storage register and 3-state outputs. Both the shift and storage register have separate clocks. The device features a serial input (DS) and a serial output (Q7S) to enable cascading and an asynchronous reset $\overline{\text{MR}}$ input. A LOW on $\overline{\text{MR}}$ will reset the shift register. Data is shifted on the LOW-to-HIGH transitions of the SHCP input. The data in the shift register is transferred to the storage register on a LOW-to-HIGH transition of the STCP input. If both clocks are connected together, the shift register will always be one clock pulse ahead of the storage register. Data in the storage register appears at the output whenever the output enable input ($\overline{\text{OE}}$) is LOW. A HIGH on $\overline{\text{OE}}$ causes the outputs to assume a high-impedance OFF-state. Operation of the $\overline{\text{OE}}$ input does not affect the state of the registers. The 74AHCT595 features TTL compatible inputs. Both 74AHC595 and 74AHCT595 inputs are overvoltage tolerant. This feature allows the use of these devices as translators in mixed voltage environments.

2. Features and benefits

- Wide supply voltage range from 2.0 V to 5.5 V
- Balanced propagation delays
- All inputs have Schmitt-trigger action
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- Input levels:
 - The 74AHC595 operates with CMOS input levels
 - The 74AHCT595 operates with TTL input levels
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
 - Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Applications

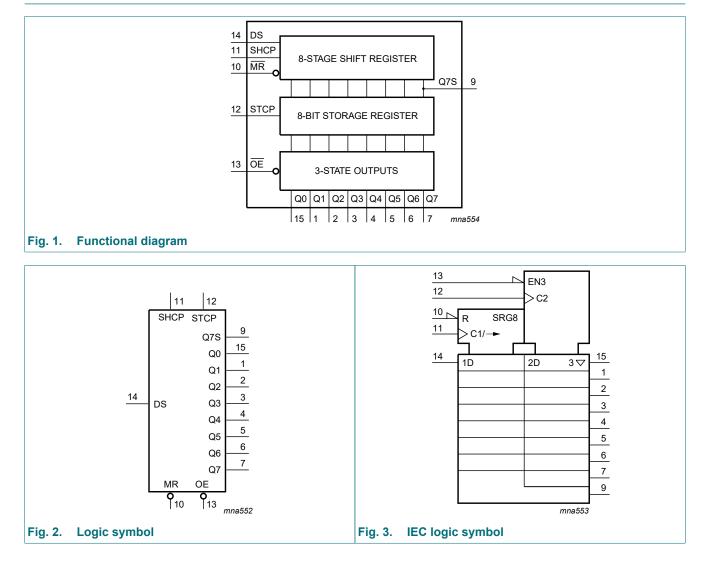
- Serial-to-parallel data conversion
- Remote control holding register



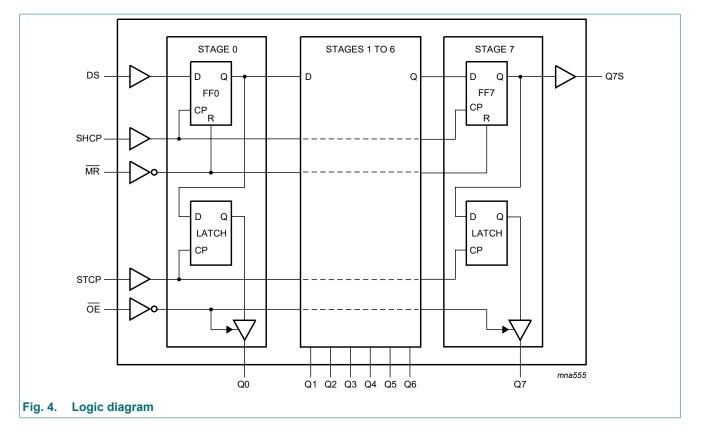
4. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AHC595D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1
74AHCT595D			body width 3.9 mm	
74AHC595PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1
74AHCT595PW			body width 4.4 mm	
74AHC595BQ	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced	SOT763-1
74AHCT595BQ			very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	

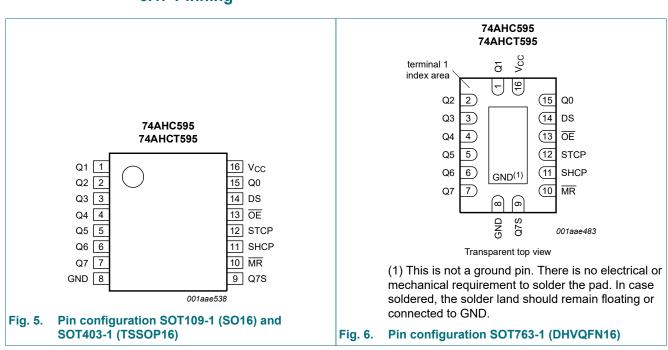
5. Functional diagram



8-bit serial-in/serial-out or parallel-out shift register with output latches



6. Pinning information



6.1. Pinning

6.2. Pin description

Table 2. Pin description		
Symbol	Pin	Description
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	15, 1, 2, 3, 4, 5, 6, 7	parallel data output
GND	8	ground (0 V)
Q7S	9	serial data output
MR	10	master reset (active LOW)
SHCP	11	shift register clock input
STCP	12	storage register clock input
OE	13	output enable input (active LOW)
DS	14	serial data input
V _{CC}	16	supply voltage

7. Functional description

Table 3. Function table

H = HIGH voltage state;

L = LOW voltage state;

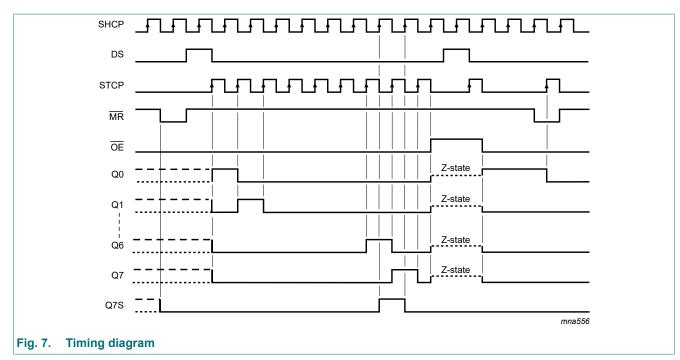
 \uparrow = LOW-to-HIGH transition;

X = don't care;

NC = no change;

Z = high-impedance OFF-state.

Contro	I			Input	Output	:	Function
SHCP	STCP	OE	MR	DS	Q7S	Qn	
Х	Х	L	L	Х	L	NC	a LOW-level on $\overline{\text{MR}}$ only affects the shift registers
Х	1	L	L	Х	L	L	empty shift register loaded into storage register
Х	Х	Н	L	Х	L	Z	shift register clear; parallel outputs in high-impedance OFF-state
↑	Х	L	Η	Н	Q6S	NC	logic HIGH-level shifted into shift register stage 0. Contents of all shift register stages shifted through, e.g. previous state of stage 6 (internal Q6S) appears on the serial output (Q7S).
Х	1	L	Н	Х	NC	QnS	contents of shift register stages (internal QnS) are transferred to the storage register and parallel output stages
↑	Î	L	Η	X	Q6S	QnS	contents of shift register shifted through; previous contents of the shift register is transferred to the storage register and the parallel output stages



8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	[1]	-20	-	mA
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	[1]	-20	+20	mA
lo	output current	$V_{O} = -0.5 V$ to ($V_{CC} + 0.5 V$)		-25	+25	mA
I _{CC}	supply current			-	+75	mA
I _{GND}	ground current			-75	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.

For SOT403-1 (TSSOP16) package: Ptot derates linearly with 8.5 mW/K above 91 °C.

For SOT763-1 (DHVQFN16) package: P_{tot} derates linearly with 11.2 mW/K above 106 °C.

9. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	7	4AHC59	95	74	АНСТ5	95	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 3.0 V to 3.6 V	-	-	100	-	-	-	ns/V
		V _{CC} = 4.5 V to 5.5 V	-	-	20	-	-	20	ns/V

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHC5	95	-								
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA; V _{CC} = 3.0 V	2.58	-	-	2.48	-	2.40	-	V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I _O = 8.0 mA; V _{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
l _l	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL};$ $V_O = V_{CC} \text{ or GND}; V_{CC} = 5.5 \text{ V}$	-	-	±0.25	-	±2.5	-	±10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	4.0	-	40	-	80	μA
CI	input capacitance		-	3	10	-	10	-	10	pF

74AHC_AHCT595

8-bit serial-in/serial-out or parallel-out shift register with output latches

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min Max		Min	Min Max	
74AHCT	595	1		1		I			1	
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	l _O = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -8.0 mA	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
l _l	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL};$ $V_{O} = V_{CC} \text{ or GND}; V_{CC} = 5.5 \text{ V}$	-	-	±0.25	-	±2.5	-	±10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	4.0	-	40	-	80	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 V$; other inputs at V_{CC} or GND; $I_O = 0 A$; $V_{CC} = 4.5 V$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance		-	3	10	-	10	-	10	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 13.

Symbol	Parameter	Conditions	25 °C				°C to 5 °C		°C to 5 °C	Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
74AHC5	95									
t _{pd}	propagation	SHCP to Q7S; see Fig. 8 [2]								
	delay	V_{CC} = 3.0 V to 3.6 V; C _L = 15 pF	-	5.7	13.0	1.0	15.0	1.0	16.5	ns
		V_{CC} = 3.0 V to 3.6 V; C _L = 50 pF	-	7.7	16.5	1.0	18.5	1.0	20.1	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	4.0	8.2	1.0	9.4	1.0	10.5	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.4	10.0	1.0	11.4	1.0	12.5	ns
		STCP to Qn; see Fig. 9 [2]								
		V_{CC} = 3.0 V to 3.6 V; C _L = 15 pF	-	5.9	11.9	1.0	13.5	1.0	15.0	ns
		V_{CC} = 3.0 V to 3.6 V; C _L = 50 pF	-	7.7	15.4	1.0	17.0	1.0	18.5	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	4.2	7.4	1.0	8.5	1.0	9.5	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.5	9.0	1.0	10.5	1.0	11.5	ns

8-bit serial-in/serial-out or parallel-out shift register with output latches

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Typ [1]	Мах	Min	Max	Min	Max	1
t _{PHL}	HIGH	MR to Q7S; see <u>Fig. 11</u>								
	to LOW	V_{CC} = 3.0 V to 3.6 V; C _L = 15 pF	-	5.9	12.8	1.0	13.7	1.0	15.0	ns
	propagation delay	V _{CC} = 3.0 V to 3.6 V; C _L = 50 pF	-	7.4	16.3	1.0	17.2	1.0	18.7	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	4.4	8.0	1.0	9.1	1.0	10.0	ns
		V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.6	10.0	1.0	11.1	1.0	12.0	ns
t _{en}	enable time	OE to Qn; see <u>Fig. 12</u> [3]								
		V _{CC} = 3.0 V to 3.6 V; C _L = 15 pF	-	5.6	11.5	1.0	13.5	1.0	15.0	ns
		V _{CC} = 3.0 V to 3.6 V; C _L = 50 pF	-	7.4	15.0	1.0	17.0	1.0	18.5	ns
		V _{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	4.0	8.6	1.0	10.0	1.0	11.0	ns
		V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.3	10.6	1.0	12.0	1.0	13.0	ns
t _{dis}	disable time	OE to Qn; see <u>Fig. 12</u> [4]								
		V _{CC} = 3.0 V to 3.6 V; C _L = 15 pF	-	5.4	11.0	1.0	13.0	1.0	14.5	ns
		V _{CC} = 3.0 V to 3.6 V; C _L = 50 pF	-	8.7	15.7	1.0	16.2	1.0	17.5	ns
		V _{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	3.8	8.0	1.0	9.5	1.0	10.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V; } C_1 = 50 \text{ pF}$	-	5.8	10.3	1.0	11.0	1.0	12.0	ns
f _{max}	maximum	SHCP or STCP; see Fig. 8 and Fig. 9								
	frequency	V _{CC} = 3.0 V to 3.6 V	80	125	-	60	-	40	-	MHz
		V _{CC} = 4.5 V to 5.5 V	130	170	-	110	-	90	-	MHz
t _W	pulse width	SHCP HIGH or LOW; see Fig. 8								
		V _{CC} = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
		STCP HIGH or LOW; see Fig. 9								
		V _{CC} = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
		MR LOW; see <u>Fig. 11</u>								
		V _{CC} = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
t _{su}	set-up time	DS to SHCP; see Fig. 10								
<u>ou</u>		V _{CC} = 3.0 V to 3.6 V	3.5	-	-	3.5	-	3.5	-	ns
		V _{CC} = 4.5 V to 5.5 V	3.0	-	-	3.0	-	3.0	-	ns
		SHCP to STCP; see Fig. 9								
		V _{CC} = 3.0 V to 3.6 V	8.5	_	-	8.5	-	8.5	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
t _h	hold time	DS to SHCP; see Fig. 10								
		V _{CC} = 3.0 V to 3.6 V	1.5	_	-	1.5	-	1.5	-	ns
		V _{CC} = 4.5 V to 5.5 V	2.0	_	-	2.0	-	2.0	-	ns
t _{rec}	recovery	MR to SHCP; see Fig. 11	-			-		-		
100	time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	3.0	-	-	3.0	-	3.0	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	2.5	_	-	2.5	_	2.5	-	ns
C _{PD}	power dissipation capacitance	power $f_i = 1 \text{ MHz}; V_i = \text{GND to } V_{CC}$ [6] dissipation		180	-	-	-	-	-	pF

8-bit serial-in/serial-out or parallel-out shift register with output latches

Symbol	Parameter	Conditions		25 °C		-	°C to 5 °C	-	°C to 5 °C	Unit
			Min	Тур [1]	Мах	Min	Max	Min	Max	
74AHCT	595								1	
t _{pd}	propagation	SHCP to Q7S; see Fig. 8 [2]								
	delay	V_{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	3.8	8.2	1.0	9.0	1.0	10.0	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.2	10.0	1.0	11.0	1.0	12.0	ns
		STCP to Qn; see Fig. 9 [2]								
		V_{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	4.0	7.4	1.0	8.5	1.0	9.5	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.3	9.0	1.0	10.5	1.0	11.5	ns
t _{PHL}	HIGH	MR to Q7S; see <u>Fig. 11</u>								
	to LOW	V_{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	4.6	8.2	1.0	9.5	1.0	10.5	ns
	propagation delay	V_{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.8	10.5	1.0	11.5	1.0	12.5	ns
t _{en}	enable time	OE to Qn; see <u>Fig. 12</u> [3]								
		V _{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	4.8	9.0	1.0	11.0	1.0	12.0	ns
		V _{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	6.2	11.6	1.0	13.0	1.0	14.5	ns
t _{dis}	disable time	OE to Qn; see <u>Fig. 12</u> [4]								
		V_{CC} = 4.5 V to 5.5 V; C _L = 15 pF	-	3.6	6.9	1.0	8.0	1.0	9.0	ns
		V_{CC} = 4.5 V to 5.5 V; C _L = 50 pF	-	5.8	10.3	1.0	11.0	1.0	12.0	ns
f _{max}	maximum frequency	SHCP and STCP; V _{CC} = 4.5 V to 5.5 V; see Fig. 8 and Fig. 9	130	170	-	110	-	90	-	MHz
t _W	pulse width	SHCP HIGH or LOW; V _{CC} = 4.5 V to 5.5 V; see <u>Fig. 8</u>	5.0	-	-	5.0	-	5.0	-	ns
		STCP HIGH or LOW; V _{CC} = 4.5 V to 5.5 V; see <u>Fig. 9</u>	5.0	-	-	5.0	-	5.0	-	ns
		MR LOW; V _{CC} = 4.5 V to 5.5 V; see <u>Fig. 11</u>	5.0	-	-	5.0	-	5.0	-	ns
t _{su}	set-up time	DS to SHCP; V_{CC} = 4.5 V to 5.5 V; see Fig. 10	3.0	-	-	3.0	-	3.0	-	ns
		SHCP to STCP; V_{CC} = 4.5 V to 5.5 V; see Fig. 9	5.0	-	-	5.0	-	5.0	-	ns
t _h	hold time	DS to SHCP; V_{CC} = 4.5 V to 5.5 V; see Fig. 10	2.0	-	-	2.0	-	2.0	-	ns
t _{rec}	recovery time	$\overline{\text{MR}}$ to SHCP; V _{CC} = 4.5 V to 5.5 V; see Fig. 11	3.0	-	-	3.0	-	3.0	-	ns
C _{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz}; V_i = \text{GND to } V_{\text{CC}}$ [5] [6]	-	190	-	-	-	-	-	pF

Typical values are measured at nominal supply voltage. [1]

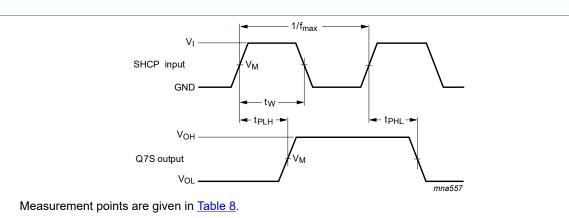
[2] [3] t_{pd} is the same as t_{PHL} and t_{PLH} .

 \dot{t}_{en} is the same as t_{PZL} and t_{PZH} .

[4] t_{dis} is the same as t_{PLZ} and t_{PHZ} . [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz; $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs; C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V. [6] All 9 outputs switching.

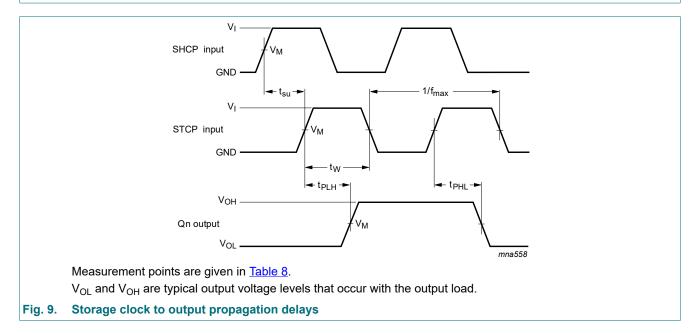
74AHC_AHCT595



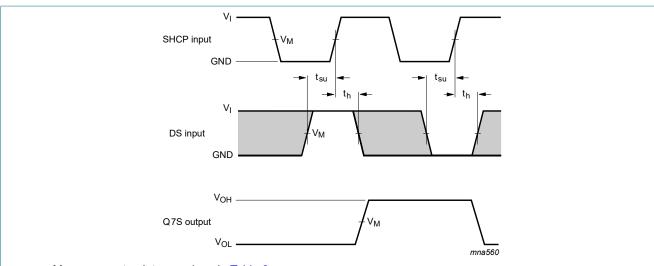
11.1. Waveforms and test circuit

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 8. Shift clock pulse, maximum frequency and input to output propagation delays



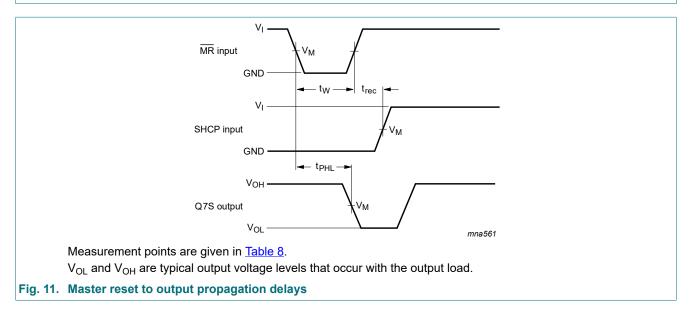
8-bit serial-in/serial-out or parallel-out shift register with output latches



Measurement points are given in Table 8.

The shaded areas indicate when the input is permitted to change for predictable output performance. V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 10. Data set-up and hold times



8-bit serial-in/serial-out or parallel-out shift register with output latches

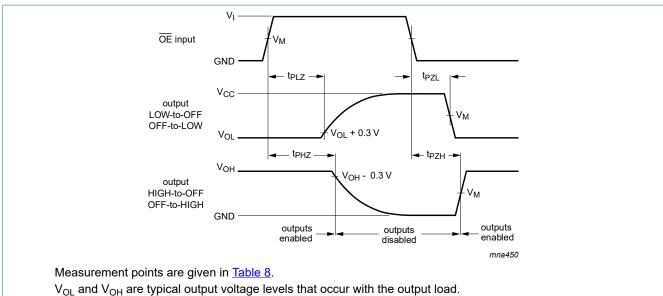


Fig. 12. Enable and disable times

Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74AHC595	0.5V _{CC}	0.5V _{CC}
74AHCT595	1.5 V	0.5V _{CC}

8-bit serial-in/serial-out or parallel-out shift register with output latches

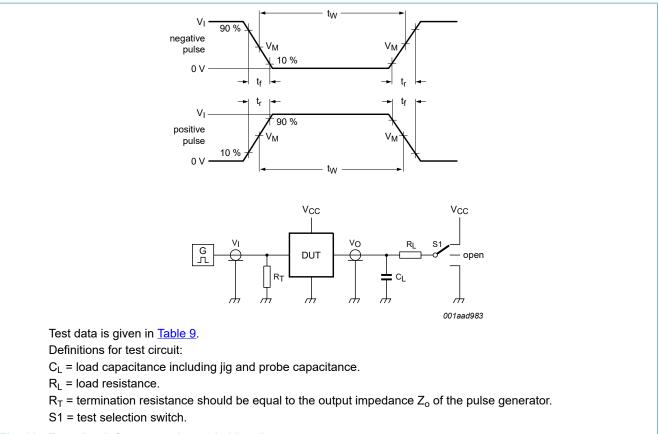


Fig. 13. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load		S1 position			
	VI	t _r , t _f	C _L R _L t _{Pl}		t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
74AHC595	V _{CC}	≤ 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}	
74AHCT595	3.0 V	≤ 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}	

12. Package outline

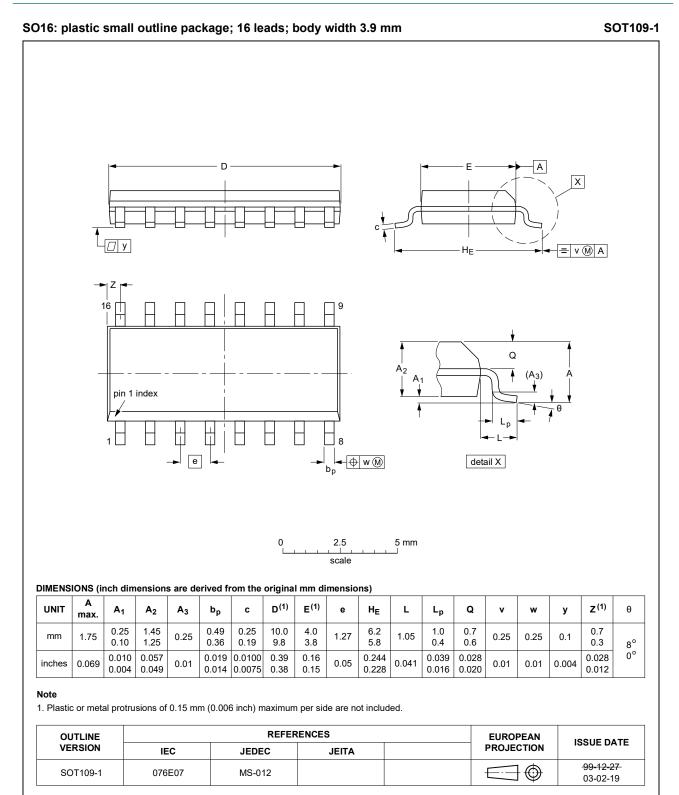


Fig. 14. Package outline SOT109-1 (SO16)

74AHC_AHCT595

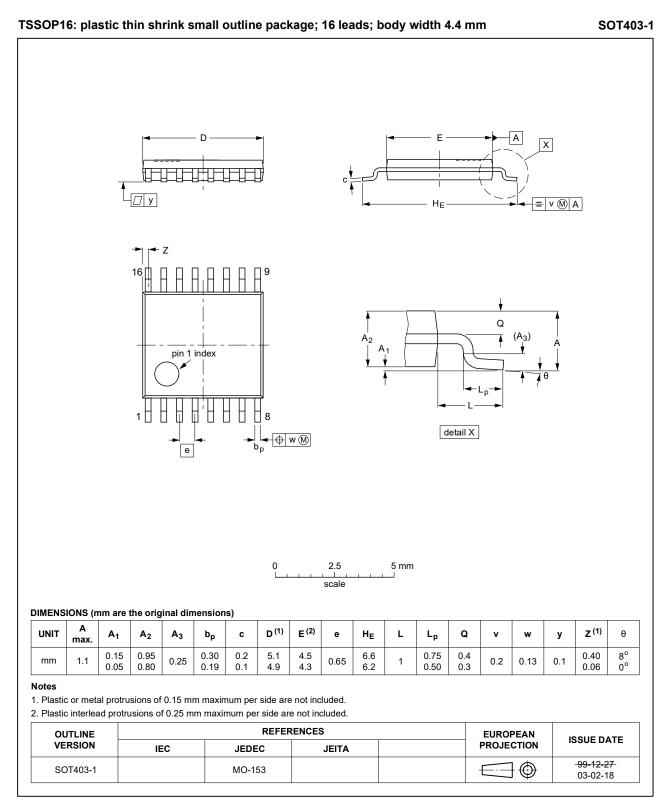


Fig. 15. Package outline SOT403-1 (TSSOP16)

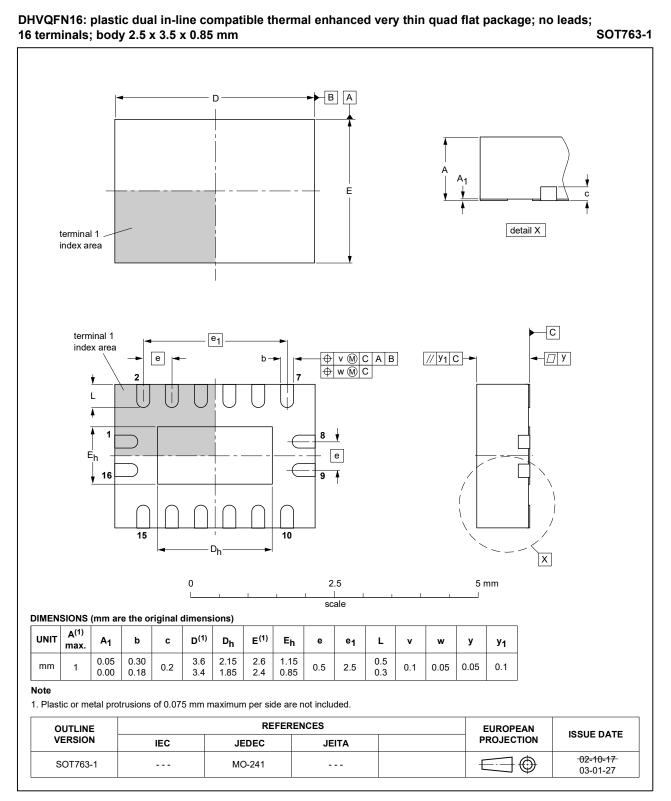


Fig. 16. Package outline SOT763-1 (DHVQFN16)

13. Abbreviations

Table 10. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT595 v.6	20200526	Product data sheet	-	74AHC_AHCT595 v.5
Modifications:	guidelines o Legal texts I <u>Section 1</u> ar <u>Fig. 7</u> : Timir <u>Table 4</u> : Der	of this data sheet has been f Nexperia. have been adapted to the r nd <u>Section 2</u> updated. ng diagram updated with SI rating values for P _{tot} total p pagation delay symbol and	new company nan HCP waveform. ower dissipation u	ne where appropriate.
74AHC_AHCT595 v.5	20120704	Product data sheet	-	74AHC_AHCT595 v.4
Modifications:	Added GND	in the pin configuration dra	awing DHVQFN1	6 (errata)
74AHC_AHCT595 v.4	20090811	Product data sheet	-	74AHC_AHCT595 v.3
74AHC_AHCT595 v.3	20080425	Product data sheet	-	74AHC_AHCT595 v.2
74AHC_AHCT595 v.2	20060323	Product data sheet	-	74AHC_AHCT595 v.1
74AHC_AHCT595 v.1	20000315	Product specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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